ISL55015

MMIC Silicon Bipolar Broadband Amplifier

FN6284
Rev 3.00
February 6, 2017

The ISL55015 is a high performance gain block featuring a Darlington configuration using high f_T transistors and excellent thermal performance. They are an ideal choice for DVB-S LNB cable receiver applications.

Other members of the family include:

- ISL55012 and ISL55015 match a 75Ω source to a 50Ω load
- ISL55014 matches a 50Ω source to a 50Ω load

Ordering Information

PART NUMBER (Notes 1, 2, 3)	PART MARKING (Note 4)	TAPE AND REEL (UNITS)	PACKAGE (RoHS COMPLIANT)	PKG. DWG. #
ISL55015IEZ-T7	CCK	3k	6 Ld SC-70	P6.049B
ISL55015IEZ-EVAL	Evaluation board			

NOTES:

1. Refer to TB347 for details on reel specifications.
2. These Intersil Pb-free plastic packaged products employ special Pb-free material sets, molding compounds/die attach materials, and 100% matte tin plate plus anneal (e3 termination finish, which is RoHS compliant and compatible with both SnPb and Pb-free soldering operations). Intersil Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.
3. For Moisture Sensitivity Level (MSL), please see device information page for ISL55015. For more information on MSL please techbrief TB363.
4. The part marking is located on the bottom of the part.

Related Literature

- For a full list of related documents, visit our website
  - ISL55015 product page

Features

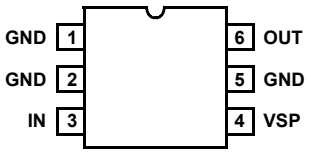
- Input impedance of 75Ω
- Output impedance of 50Ω
- Gain of 13.5dB at 1GHz
- Noise figure of 4.8dB at 2GHz
- OIP3 of 31dBm at 1GHz
- Low input and output return losses
- Pb-free (RoHS compliant)

Applications

- LNB and LNB-T (HDTV) amplifiers
- IF gain blocks for satellite and terrestrial STBs
- PA driver amplifier
- Wireless data, satellite
- Bluetooth/WiFi
- Satellite locator and signal strength meters

Pin Configuration

ISL55015
(6 LD SC-70)
TOP VIEW



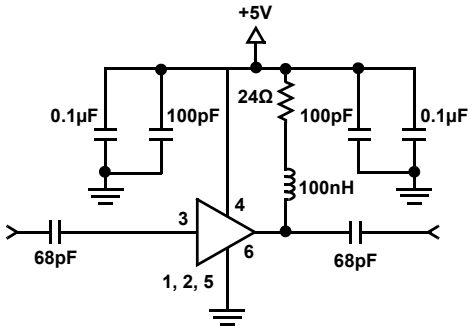


FIGURE 1. TYPICAL APPLICATION CIRCUIT

TABLE 1. KEY DIFFERENCES BETWEEN FAMILY OF PARTS

PART #	IMPEDANCE		GAIN AT 1GHz (dB)	NOISE FIGURE AT 2GHz (dB)
	SOURCE (Ω)	LOAD (Ω)		
ISL55012	75	50	18	4.7
ISL55014	50	50	17.2	4.3
ISL55015	75	50	13.5	4.8

Absolute Maximum Ratings (T_A = +25°C)

Supply Voltage from V_{SP} to GND 6V
Input Voltage ..... V_S+ +0.3V to GND - 0.3V
ESD Rating
Human Body Model (Per MIL-STD-883 Method 3015.7) 6000V
Machine Model (Per EIAJ ED-4701 Method C-111) 250V

Thermal Information

Thermal Resistance (Typical)	θ_{JA} (°C/W)	θ_{JC} (°C/W)
6 Ld SC-70 (Notes 5, 6)	255	195

Storage Temperature ..... -65°C to +125°C
Operating Junction Temperature ..... +135°C
Pb-Free Reflow Profile ..... see TB493

Recommended Operating Conditions

Ambient Operating Temperature ..... -40°C to +85°C

CAUTION: Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions may adversely impact product reliability and result in failures not covered by warranty.

NOTES:

5. θ_{JA} is measured with the component mounted on a high-effective thermal conductivity test board in free air. See Tech Brief TB379 for details.
6. For θ_{JC}, the "case temp" location is taken at the package top center.

Electrical Specifications

V_{SP} = +5V, Z_{RSC} = Z_{LOAD} = 50Ω, T_A = +25°C, 24Ω V_{SP} to OUT, unless otherwise specified.

PARAMETER	SYMBOL	TEST CONDITIONS	MIN (Note 7)	TYP	MAX (Note 7)	UNIT
Supply Voltage	V_{SP}	To operate below 5V, the 24Ω resistor to supply should be reduced	3.0		5.5	V
Small Signal Gain	Gt	1.0GHz	12.3	13.5	14.8	dB
		1.5GHz	11.7	13.3	14.2	dB
		2.0GHz	11.0	12.4	13.5	dB
Output Power at 1dB Compression	P1dB	1.0GHz	16.4	18.1	21.6	dBm
		2.0GHz	15.3	19.4	21.0	dBm
Output Third Order Intercept Point	OIP3	1.0GHz		31.3		dBm
		2.0GHz		28.4		dBm
Output Second Order Intercept Point	OIP2	Input tones at 1.0GHz and 1.1GHz, at Input Power = -15dBm, Output tone 2.1GHz		47		dBm
3dB Bandwidth	BW	3dB below Gain at 500MHz		2.9		GHz
Input Return Loss	IRL	1.0GHz Z_{RSC} = 75Ω, Z_{LOAD} = 50Ω		20.2		dB
Output Return Loss	ORL	1.0GHz Z_{RSC} = 75Ω, Z_{LOAD} = 50Ω		21.4		dB
Reverse Isolation	RISOL	2.0GHz		18.9		dB
Noise Figure	NF	2.0GHz		4.8		dB
Device Operating Current	ID		54	62.5	69	mA

NOTE:

7. Parameters with MIN and/or MAX limits are 100% tested at +25°C, unless otherwise specified. Temperature limits established by characterization and are not production tested.

Device Test Setup

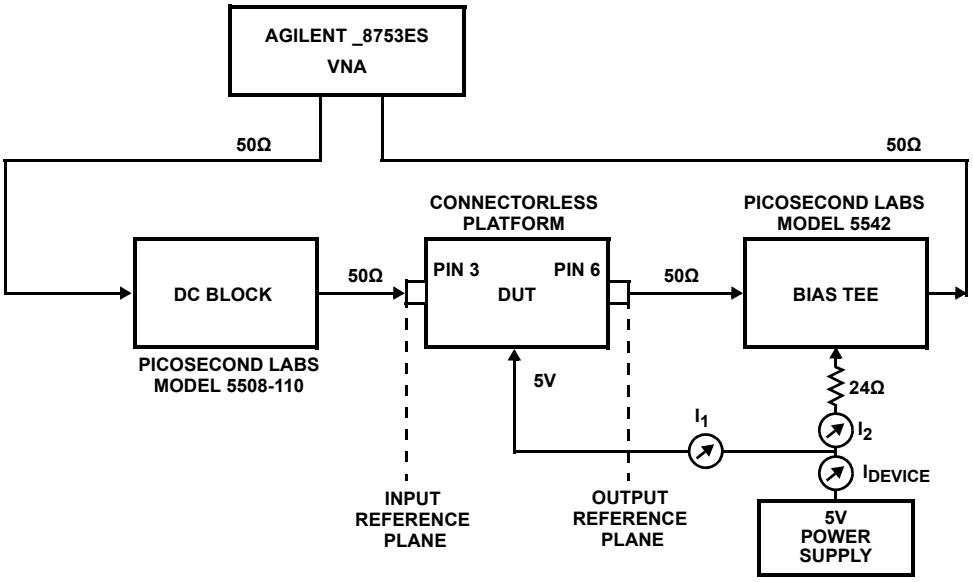


FIGURE 2. DEVICE TEST SETUP

Typical Performance Curves Z_{SRC} = 75Ω, Z_{LOAD} = 50Ω

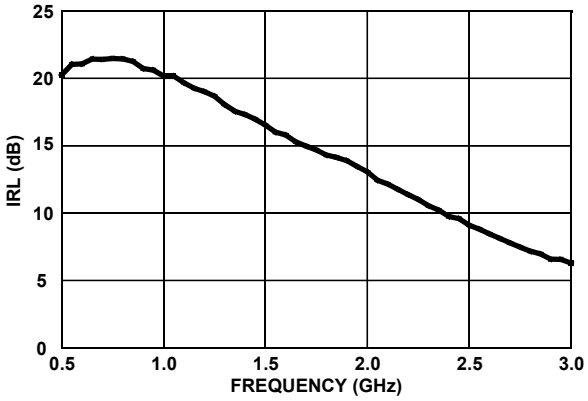


FIGURE 3. INPUT RETURN LOSS vs FREQUENCY

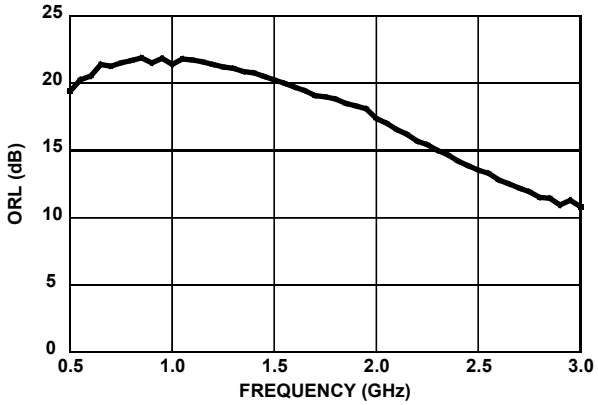


FIGURE 4. OUTPUT RETURN LOSS vs FREQUENCY

Typical Performance Curves 50Ω environment

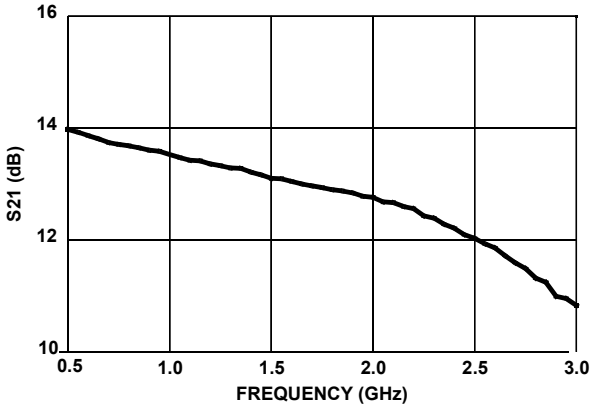


FIGURE 5. |S21| vs FREQUENCY

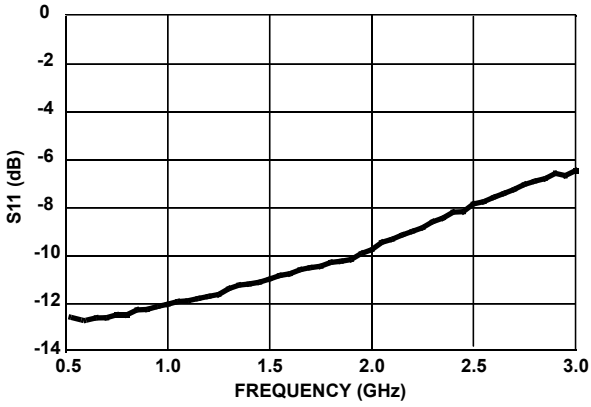


FIGURE 6. |S11| vs FREQUENCY

Typical Performance Curves 50Ω environment (Continued)

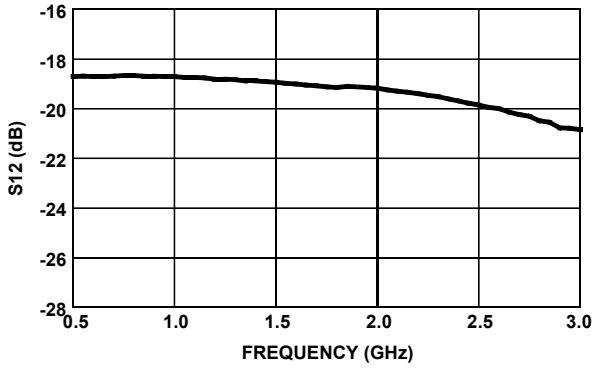


FIGURE 7. |S12| vs FREQUENCY

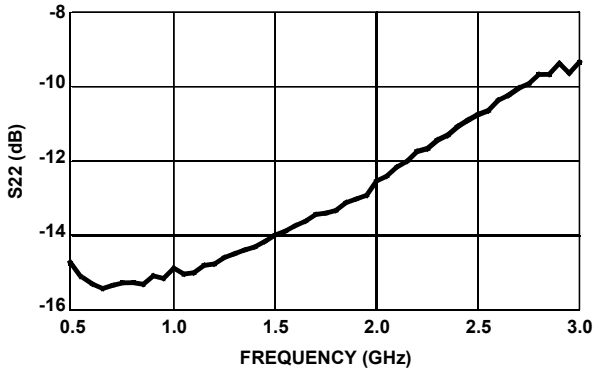


FIGURE 8. |S22| vs FREQUENCY

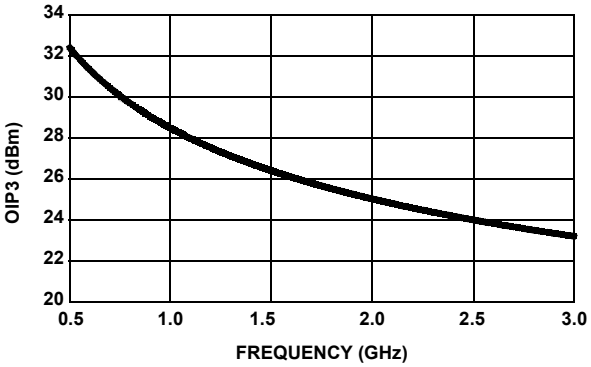


FIGURE 9. OIP3 vs FREQUENCY

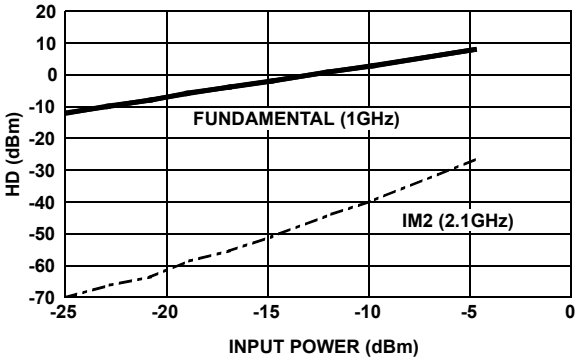


FIGURE 10. IM2 vs INPUT POWER

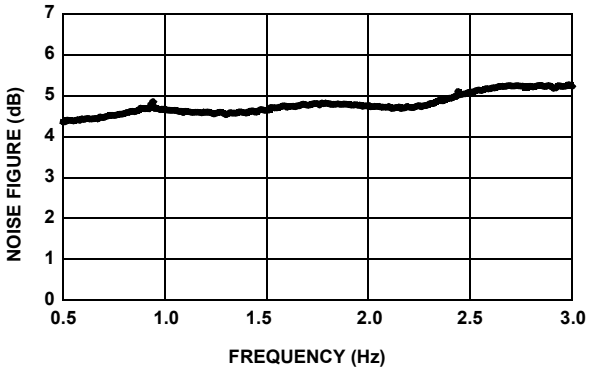


FIGURE 11. NOISE FIGURE vs FREQUENCY

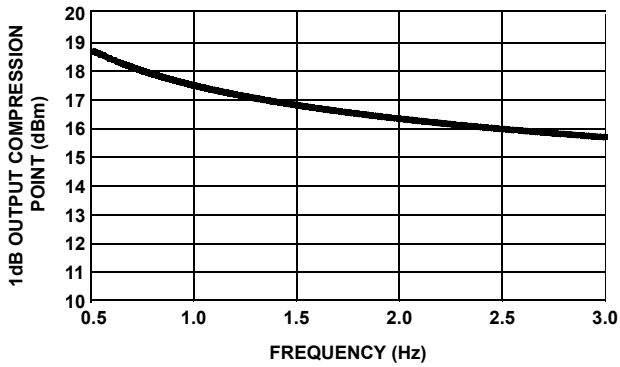


FIGURE 12. P1dB vs FREQUENCY

Typical Performance Curves 50Ω environment (Continued)

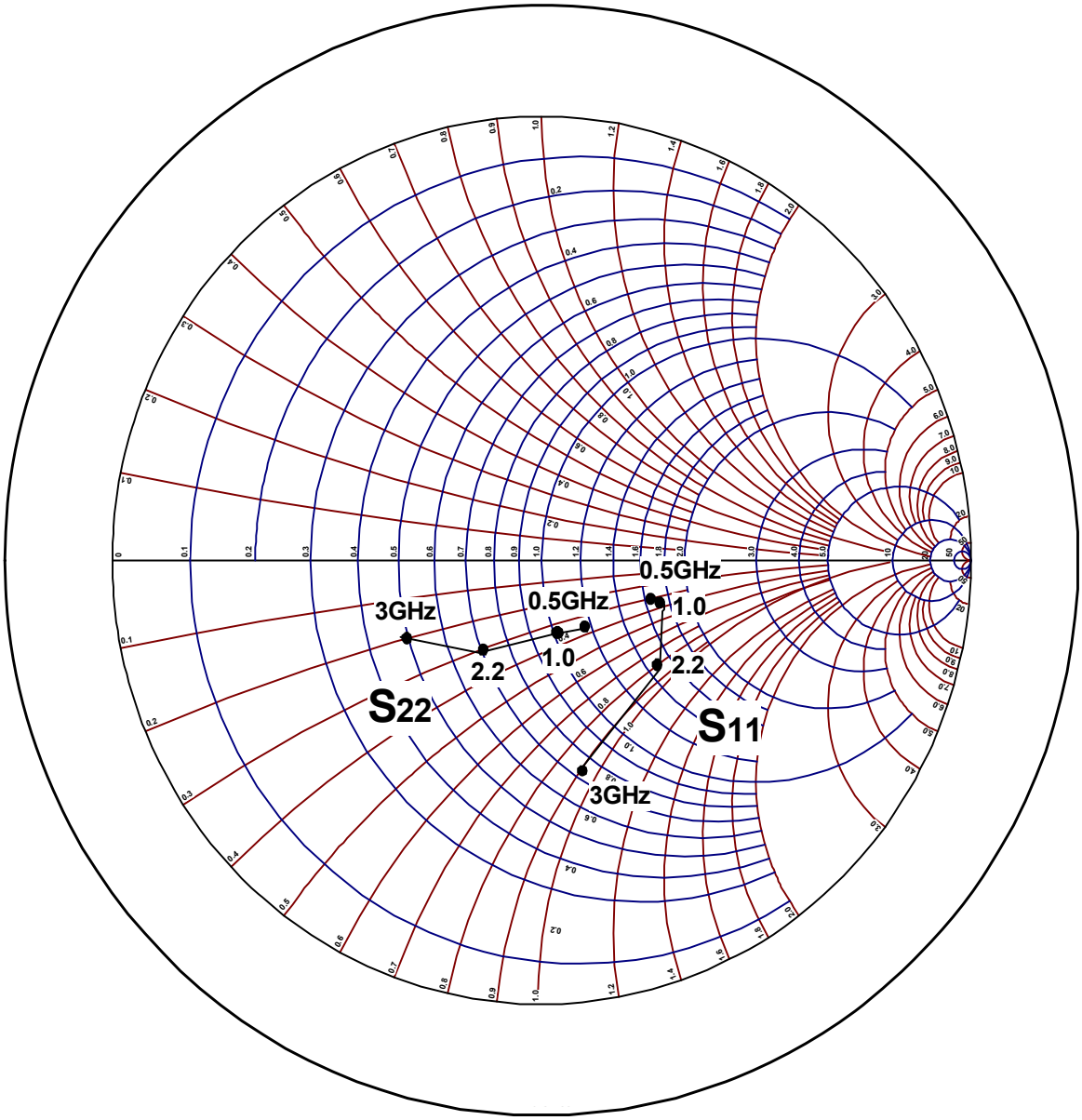


FIGURE 13. S11 AND S22 vs FREQUENCY

Revision History

The revision history provided is for informational purposes only and is believed to be accurate, but not warranted. Please visit our website to make sure you have the latest revision.

DATE	REVISION	CHANGE
February 6, 2017	FN6284.3	Removed mention of obsolete part ISL55013. On page 1: Updated Ordering Information table - added ISL55015IEZ-EVAL and added column for tape & reel quantity. Added Related Literature and Table of Differences. Thermal Resistance on page 2: Moved Storage Temperature and Operating Junction Temperature from Abs Max to Thermal Information section. Added Recommended Operating Conditions section and moved Ambient Operating Temperature to this section from Abs Max. Added Revision History and About Intersil sections.

About Intersil

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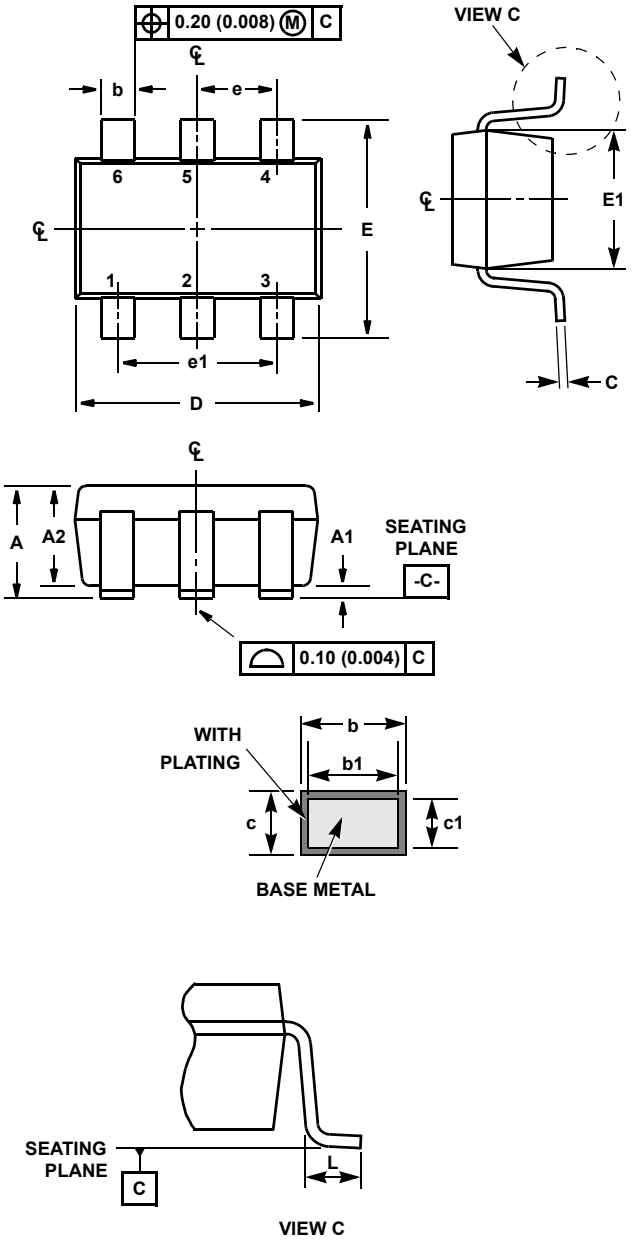
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Small Outline Transistor Plastic Packages (SC70-6)



P6.049B

6 LEAD SMALL OUTLINE TRANSISTOR PLASTIC PACKAGE

SYMBOL	MILLIMETERS		NOTES
	MIN	MAX	
A	0.80	1.00	-
A1	0.000	0.09	-
A2	0.80	0.91	-
b	0.15	0.30	-
b1	0.15	0.25	-
c	0.08	0.25	6
c1	0.10	0.15	6
D	1.85	2.25	3
E	2.30 BSC		-
E1	1.15	1.35	3
e	0.65 Ref		-
e1	1.30 Ref		-
L	0.21	0.44	4
N	6		5

Rev. 0 4/07

NOTES:

1. Dimensioning and tolerance per ASME Y14.5M-1994.
2. Package conforms to EIAJ SC70 and JEDEC MO203AB.
3. Dimensions D and E1 are exclusive of mold flash, protrusions, or gate burrs.
4. Footlength L measured at reference to gauge plane.
5. “N” is the number of terminal positions.
6. These Dimensions apply to the flat section of the lead between 0.08mm and 0.15mm from the lead tip.

For the most recent package outline drawing, see P6.049B.